

Index

A

Abrasion, 4–5, 15–16, 31, 33–36, 42, 49, 61, 99–101, 103–104, 173, 208, 226, 228, 230

Abrasion resistant coating, 61, 101

Abrasive resistance, 29–30, 34, 37, 43, 44–45, 47, 60, 63, 228–232

Accumulation, 8, 43, 192, 199–200, 242

Adatom, 114, 127, 237

Adhesives, 4, 236

Aero gel, 7, 9

Agglomeration, 2, 9, 50, 80, 113, 152, 164, 166–167, 169, 178, 201, 225, 235

Air pollutants, 44, 231

Alco gel, 7

Aluminum oxide, 21, 34, 38–39, 230

Amalgamation, 6, 164, 226

Amorphous, 6, 30–32, 36, 40–42, 52, 56, 60, 94, 150, 175, 191, 201, 226, 229, 231–233

Anatase, 2–3, 149

Anisotropy, 36, 59

Annealing, 13, 56, 58, 86, 94, 153, 195, 200–202, 227–228, 234, 239, 243

Anode, 111, 113–114, 126, 129

Anti corrosive coating, 5

Anti fog, 5, 15, 226

Anti scratch, 15

Antibacterial coating, 101, 213

Anti-bacterium masks, 210

Anti-corrosive properties, 133

Antipollution, 212–214

Antistatic, 92–93

Asymptotic analysis, 155

Atomic force microscopy (AFM), 166

Atomic nucleation theory, 116

Atomic vibration, 5, 226

Atomistic simulation, 154

Atoms, 1, 12–13, 15, 34, 55–56, 77, 79, 90–91, 94–95, 111–112, 114–116, 118, 127–128, 135, 197, 199, 200, 220, 227, 230, 237

Automobile industry, 37, 65, 209

Average current density, 47, 119

Average size of nanometric particulates (ASNP), 175

B

Band gap energy, 2, 149, 187, 225, 241

Binding energy, 5, 188

Biocompatibility, 31

Bio-stability, 31

Butler-volmer equation, 131

C

Cantilever, 38, 72

Carbon nanotubes, 2, 49–51, 112–113, 121

Catalyst, 4, 7–8, 11, 44, 52, 60, 133, 187, 209, 213, 226–227, 231, 234

Catalyst properties, 52, 133, 209, 234

Catalytic systems, 85

Cathode, 39, 111, 114–115, 119, 125–130, 162, 166, 168, 170, 236–237

Cathodic over-voltage, 114

Celice model, 162

Ceramics, 3, 6–7, 9, 30, 61, 66, 68, 85, 101–102, 135, 225–226, 229

Cerium oxide, 10

Characterization, 77, 180, 182, 192

Charge transfer, 118, 122, 127–128, 131

Chemical barriers, 5

Chemical collide, 4

C (cont.)

Chemical composition, 4, 78–79, 83–84, 92–93, 96, 133–134, 226, 235, 238

Chemical elements, 4

Chemical potential, 91–92, 94–95, 113–114, 163

Chemical reaction, 4, 7, 10, 51, 94, 96, 119, 127, 167, 236

Chemical synthesis, 4

Chemical vapor deposition (CVD), 4–6, 29, 150, 226, 229

Chromium oxide, 34, 230

Clusters, 1, 3, 95, 214

CMOS, 189, 192, 242

Coercivity, 47

Coherency, 84

Cohesion, 30–31, 33–36, 45, 100, 103, 211, 215, 230, 232

Commercial methods, 4

Compact structure, 35

Compatibility, 17, 31, 63, 65–66, 97–98, 103, 190, 203, 211, 228

Complex compound, 127

Compressed metals, 94

Compression, 95, 157

Compressive stress, 90

Concentration over-potential, 127

Conduction, 5

Convection phenomena, 112

Corrosion current density, 112

Cosmetics, 4, 226

Creep, 35, 48, 49, 59, 65, 133, 230, 233, 234, 238

Creep rate, 48–49, 238

Crushing, 103

Crystalline, 4, 6, 21, 30–31, 34–36, 40–42, 44–45, 47–49, 52, 54–60, 71, 75, 77–81, 83–85, 89, 92–96, 100, 111, 114, 128, 131, 133–135, 139, 152, 156, 174, 183, 192, 201–202, 226, 229, 231–235, 138, 242–243

Crystalline nuclei, 111

Crystalline structure, 4, 44, 55, 58, 77, 79–80, 83–85, 92, 174, 231, 235

Crystallization of glassy phases, 96

Cyclic loading, 160

D

Data storing capacity, 216

Decomposition, 79, 95, 127

Densification, 8

Density of deposited metal, 39

Detergents, 4, 226

Dielectric constant, 135–137

Dip coating, 82

Dislocation, 35–36, 42, 48–49, 77, 85, 156–161, 230

Dispersant, 80, 153–154, 164–166, 239

Dispersion hardening, 97

Dissolution methods, 4

Distribution, 3, 32, 37–38, 43–44, 48–51, 53–54, 58, 79, 89, 92, 112–113, 116, 120–121, 123–125, 133–134, 152–156, 164, 167, 169, 171, 175–176, 196, 208, 225, 229, 231, 234, 236, 238–239, 244

Double layer, 112, 124–128, 130–132, 163–166, 169

Double-layer structure, 124–125

Driving force, 79, 84, 91, 95, 111, 114, 134, 196, 199

Drying process, 2, 149, 151

Ductility, 35, 42, 45, 153, 232, 239

Duty cycle, 37, 50–53, 112–113, 116, 162, 170, 175

E

Elastic strain, 90

Elastic stress, 90

Elastic tension, 90

Elcho oxide orbit, 7

Electrical, 3–4, 16–17, 34, 39, 43, 45, 56, 58–60, 62, 66, 77–78, 82, 85–87, 94–96, 99–102, 111–112, 124–128, 130–133, 152, 154, 162–163, 165–167, 169, 176–177, 201–203, 207, 212, 214–217, 224, 228, 237, 239, 243

Electrochemical deposition, 78, 96, 111, 129, 130, 132, 237

Electrochemical deposition process, 96, 111, 129, 237

Electrochemical nucleation, 123

Electrochemical phase state, 119

Electrochemical potential of electrolyte, 113

Electrochemical properties, 93, 111, 113, 138

Electrochemical supersaturation, 114

Electrochemistry, 29, 46, 141, 232, 233

Electro-crystallization, 47, 111, 116

Electrode surface energy state, 119

Electrodeposition, 5, 40, 49–50, 52, 69, 97, 121, 146, 152, 174–175, 178, 234

Electro-explosion, 4

Electromagnetic compatibility, 203

Electron-phonon collision, 206, 244
 Electrostatic sustainability, 165
 Entangle bonding energy, 164
 Enthalpy, 93–95
 Environmental modification, 4, 226
 Equilibrium state, 77, 83, 91–92, 94, 113–115, 192, 206
 Evaporation, 6, 36, 48, 55, 64, 95, 226, 233
 Exchanged current density, 39

F

Fabrication methods, 6
 Faraday constant, 39, 94, 126
 Fatigue strength, 171, 240
 Finite element implementation, 160
 Florescence, 226
 Foliating, 173, 241
 Foliation, 99, 102, 236
 Food packaging, 16, 211–212, 244
 Free energy, 77, 85, 88–95, 195–196, 199, 235
 Friction, 15, 38, 45, 47, 49, 121, 132–133, 150, 153, 162, 170, 174, 230, 238–239
 Fullerenes, 2
 Functional application, 59
 Functionally graded coating (FGC), 32

G

Galvanic potential, 114
 Gamma function, 120
 Gas annealing, 13, 228
 Gas phase pyrolysis of flame, 4
 Gas-condensation process, 96
 Gasro gel, 7
 Gibbs free energy, 85, 93, 196, 235
 Gibbs-thomson equation, 115
 Glasses, 7, 9, 15–16, 61, 64, 100, 102, 209
 Gouy-chapman model, 125–126
 Grain boundary, 40, 48–49, 52, 54, 56–58, 78–79, 84, 94–95, 130, 132–135, 153, 159, 161, 232, 238
 Grain size, 34, 39, 41–42, 45, 47–49, 52, 54–56, 58–60, 89, 94–96, 132–134, 156, 171, 178, 193–194, 201, 230–232, 234, 237–238, 241, 243
 Granule size, 78, 133, 238
 Grinding, 4, 30, 48, 96, 157, 233, 241
 Guglielmi, 39, 60, 162–163, 222
 Guglielmi model, 39, 162–163

H

Hall-petch, 48–49, 59, 132, 156–157, 233–234, 238–240
 Hardness, 15, 17, 29–36, 41–42, 45, 47–52, 60, 100, 102, 112, 149, 152–154, 162–163, 170, 173–175, 211, 214, 228–233, 238–239, 241
 Helmholtz-perrin model, 125
 High temperature inertness, 97
 High velocity oxygen fuel spraying, 29
 Holmholtz free energy, 92
 Homogenous system, 92
 Hybrid sol, 2
 Hydro gel, 7
 Hydrogen-reduction reaction, 134
 Hydrogen solubility, 47
 Hydrogen transition, 54
 Hydrolysis, 2, 7–8, 10–11, 136, 227
 Hydrolysis reaction, 2, 7–8, 10–11, 136, 227
 Hydroxyapatite, 31, 144, 211, 229
 Hydroxyl groups, 102
 Hygienic, 16, 210

I

Infrared, 25, 100, 203–205, 243
 Inhibition efficiency, 78
 Insulation, 5
 Integrated circuits, 5, 135, 185
 Interface atoms, 55
 Interface curvature, 83
 Interface free energy, 83, 90
 Interface traction, 86
 Interfaces thermodynamics, 85
 Inter-level connections, 83
 Intra-crystalline spaces, 55
 Intra-granular, 54
 Ion exchange, 85
 Ionic activity, 114–115
 Ionic conductivity, 55–57
 Ionic radius, 124–125
 Iso electric point, 153, 168–169, 239

K

Kinetic, 77–78, 117–120, 124, 197, 236

L

Langmuir absorption isotherm, 39
 Laser abrasion, 4
 Lattice imperfections, 84
 LCD monitors, 62

L (*cont.*)

Light resistant panels, 61, 101
 Light valves, 5
 Local corrosion, 52, 54, 132, 134, 238
 Lubricants, 4, 226
 Luminescent properties, 201

M

Magnetic, 3–5, 16–17, 36, 38, 55–56, 59, 62, 72, 79, 94, 133, 149, 203–204, 216, 225–226, 228, 235, 243
 Magnetic nano-layers, 62
 Magnetron sputtering, 6, 27, 205, 226, 243
 Malleability, 47–49, 59, 223–224
 Mechanical, 3–5, 13, 30–39, 42–45, 48, 59, 63, 69, 70–71, 73, 79, 80, 88, 96, 112, 121, 132–133, 151–157, 171–172, 174, 190, 192–194, 225–226, 229–230, 232–235, 238–239
 Mechanical alloying, 4, 192–194, 242
 Mechanical properties, 5, 31–33, 35, 37, 42–43, 45, 48–50, 59, 71, 79, 112, 132, 133, 149, 153–154, 156–157, 226, 229, 232, 234–235, 238–239
 Medical applications, 16, 61
 Membranes, 42
 Metal capacity, 39
 Metal cation, 10, 124, 127, 236
 Metal chalcogenide, 201
 Metal ion structure, 124
 Metal lattice, 126, 136
 Metallic ions, 10, 94, 111–114, 126, 152, 237–238
 Micro electromechanical systems (MEMS), 36
 Micro/nano-systems, 156–157, 161, 240
 Microelectronics, 185, 203
 Milling, 4, 80, 96, 192–194
 Mineral materials, 5, 7
 Miniaturization, 185
 Mole fraction, 92
 Molecular electricity, 2
 Molecular machinery, 1
 Molecules, 1, 12, 25, 39
 Monomer, 8, 12, 227
 Mosfet, 185, 189
 Multi-crystalline, 45, 49, 52, 55–56, 78, 84–85, 89, 94–95, 134, 234–235, 238
 Multi-layers, 29–30, 35, 65, 79, 174, 229, 235

N

Nano porous material, 2, 9
 Nano yarn, 9
 Nano-capsule, 2
 Nanocoating, 29, 58
 Nanocomposite
 Nanocomposite coatings, 37, 43–44, 69, 97, 116, 146, 150–152, 174–177, 179, 238–239
 Nano-crystalline alloys, 84
 Nanocrystalline coatings, 35
 Nano-crystalline nickel, 41, 45
 Nanofibers, 2
 Nano-hybrid particles, 2, 149, 187, 225, 241
 Nanometric scale, 1, 83, 116, 175, 225
 Nano-nucleuses, 122
 Nano-particle masks, 210
 Nanoparticles, 3–4, 16, 40, 61, 97, 121–122, 136, 149–154, 162, 166–167, 169–170, 177–179, 182, 206–207, 213, 216, 225–226, 230, 239, 244
 Nano-porous materials, 2
 Nano-powders, 29, 30, 44, 85–86
 Nanorod, 79, 235
 Nano-scale thickness, 154–155, 225
 Nanostructured coating, 1, 15, 27, 29, 45
 Nanostructured films, 6, 201, 226
 Nanostructured materials, 2, 78–79, 83–85, 93–96, 133, 152, 203, 234–235, 238
 Nanosystems, 1, 157
 Nanotechnology, 1, 3–4, 15, 99, 225–226, 228
 Nano-whisker, 79, 235
 Nano-wires, 2, 29, 46–47, 98, 152, 158
 Nernst equation, 114
 Neutral surface, 114
 Neutralization, 84
 Nickel-alumina nanocomposite coating, 152–153, 166, 239
 Non-linear optical properties, 201
 Non-oxide ceramics, 3, 225
 Norio taniguchi, 1
 Nuclear pellet, 1
 Nucleation, 77–78, 96, 112, 114–121, 123, 127–128, 130, 158, 236
 Nucleus situation, 120
 Nucleuses, 111–124, 191, 198, 236

O

Off-pulse time, 129–132, 237
 Olation, 10
 On-pulse time, 129–131, 237
 Opaque, 5, 100, 203, 226

- Optical, 3–5, 13–17, 34, 38, 61, 64, 99, 149, 201, 203–205, 207–208, 225–226, 228, 243
- Optical entrapment, 5, 226
- Optical features, 4
- Organic contaminator, 44
- Organic ligand, 233
- Organic thin films, 5
- Oxolation, 10
- P**
- Particle growth, 8, 10
- Particle polymerization, 8
- Permeability, 47, 54–55, 85
- Pesticides, 4
- Phase interface, 93
- Phase isolation, 92
- Phase transition, 86, 199
- Photo-catalysts, 44, 231
- Physical properties, 6, 36, 38
- Physical vapor deposition (PVD), 6, 29, 150
- Pitting corrosion, 135
- Plasma arc plating, 11
- Plasma arc spraying, 11
- Plasma coating, 12
- Plasma polymer precipitation, 12, 227
- Plasma scattering coating, 11
- Plasma spray technology, 66
- Plasma synthesis, 4
- Polarizer, 16, 62, 215
- Polarizer nano-layers, 215
- Polyethylene, 38, 64, 230
- Polytetrafluoroethylene, 38, 152, 238
- Porosity value, 129, 237
- Porous templates, 46
- Potential energy, 5, 226
- Power generation industry, 65
- Pulsed current, 36, 40, 49–51, 53, 112, 116, 175, 178
- Q**
- Quantum dots, 2, 176, 217
- Quantum phenomena, 98
- Quantum size effect, 2–3, 149, 187, 204, 225, 241–243
- R**
- Rate of electrode reactions, 126
- Reductant agents, 111
- Reduction, 9, 15
- Reflection, 4–5, 61, 99, 209–210, 226
- Resistance over-potential, 128
- Response surface methodology, 36–37, 175
- Reversible work, 90
- Richard feynman, 1
- Rotating coating, 5
- S**
- Saint-Venant's principle, 154
- Salicide, 189–192
- Salt spray test, 132, 134
- Scale of nano, 1, 225
- Scanning electron microscope (SEM), 3
- Scanning tunneling microscopy (STM), 111
- Scratch resistance, 4, 100, 175, 226
- Scratching, 35, 103
- Sealants, 4, 226
- Self assembling, 5
- Self-cleaning glasses, 16, 209
- Self cleaning properties, 4, 101, 226
- Self-lubricity, 97
- Semi-conductor wafers, 5
- Semi-spherical nucleus, 122–123, 236
- Sensing characterization, 192
- Separation, 79, 119, 129, 237
- Setric forces, 165
- Setric sustainability, 164–165
- Silicates, 3, 225
- Silicide, 185–186, 189–193, 196, 198, 201, 203, 214, 241–242
- Silicides specifications, 189
- Silicon nitride (Si_3N_4), 3
- Size dependency, 29, 36, 171, 175, 217
- Size effect, 1–3, 31–32, 56–57, 85, 86, 111, 135, 137, 149, 154–161, 187, 189, 192, 201, 204, 225–226, 240–243
- Size-dependent phenomenon, 154
- Sodium benzoate, 78
- Sodium nitrate, 78
- Solar cells, 62, 214–215
- Sol-gel, 2, 4–10, 13–14, 30, 80–83, 86, 102, 187, 193
- Solid solubility, 47
- Solid state method, 4
- Specific heat, 79, 93–94, 235
- Spin-coating, 80
- Spray coating, 5, 17
- Stern-graham model, 226
- Stiffness, 5, 132–133, 150, 155, 159, 238
- Stillinger-weber model, 155
- Strain hardening rate, 156, 159, 240
- Strain-to-failure, 5

S (*cont.*)

Strength, 15, 30, 34, 37, 42, 44–49, 54, 59, 61, 104, 132, 149–150, 153, 156–161, 170, 172–173, 204–205, 210, 228, 231, 233–234, 239–241, 243

Strength enhancement, 173

Stress corrosion cracking, 47

Stress gradient, 83, 235

Structural applications, 59, 63

Structural disorder, 55–56

Super elasticity, 150

Super hard, 29, 35

Super-hard coatings, 29

Super-lattice coating, 36

Super rough, 35

Supersaturated state, 114

Surface elasticity, 154–155, 239

Surface engineering, 16–18, 60, 63–65, 228, 232

Surface geometry, 5, 226

Surface stress, 88, 154–155

Surface-to-volume ratio, 158

Surfactant, 43, 46, 164, 167, 233

Suspension, 6, 8, 152, 165, 168–169, 226, 238

T

Tabularization, 173

Tafel polarization, 112, 116

Taguchi method, 40, 97, 121

Tensile stress, 88

Tertiary nanocomposite, 40, 121–122, 178

Thermal capacity, 79, 235

Thermal evaporation, 6, 226

Thermal expansion, 44–45, 47, 82–84, 132, 211, 231–232

Thermal extension coefficient, 79

Thermal light, 100

Thermal oxidation, 13–14

Thermal scattering coating, 11

Thermal stability, 29, 41, 47, 58, 187, 190–192, 195–202, 207, 228, 234, 242

Thermodynamic equilibrium, 113

Thermodynamics, 83, 85–86, 235

Thermoelectric tools, 5

Thickness, 1, 4–5, 8–9, 32, 35–36, 42, 44, 48, 55–60, 80, 83, 98, 126–128, 135–137, 149–150, 154–156, 158, 170–172, 174, 186–187, 189–192, 197–208, 225–226, 229–231, 239–243

Thin film transistor (TFT), 15

Thin films, 2, 4–6, 9, 11–12, 15, 42, 56–57, 84, 124, 149, 156, 158, 169–171, 202–204, 206, 208–209, 214, 226–227, 243–244

Titanium aluminide nitride, 33

Titanium boro-nitride, 33

Titanium carbo-nitride, 33

Titanium nitride, 33–36, 229–230

Torsion, 160

Transformer, 59

Transitional metal nitride coatings, 29, 33, 228

Transparency, 4–5, 226

Transparent conductor coatings, 62, 213

Transparent glass, 9

Transpassive behavior, 134

Tungsten carbide, 38, 41, 45, 100, 177–178, 232

Turbine fans, 101

Two dimensional nano-films, 154

U

Ultrasonic bath, 49

Ultrasonic energy, 43, 167

Ultra-thin films, 171

Ultraviolet, 2, 14, 99–100, 149, 187, 204–206, 208–209, 213, 225, 236, 241–243

Ultraviolet beam, 99–100, 236

Ultraviolet-visible spectroscopy (UV-VIS), 2, 187, 241

Ultraviolet-visible spectrum, 2, 149

Uniaxial tensio, 156–157

V

Vacancy, 57, 77, 132

Vacuum annealing, 13, 228

Vacuum chamber, 6

Van der waals force, 164

Vapor resistant layers, 16

Vertex energy, 89

Viscosity, 8–9, 168–169

Volatile organic compounds, 65

Volumetric percentage, 39, 152, 154, 162, 167–168, 239

W

Water memory, 86

Water repellence, 5, 226

Waveguides, 5

Wavelengths, 4

Wear, 5, 15–16, 30, 37, 47, 49, 60–61, 82, 97,
103, 121, 173, 174, 176–179, 217,
226, 228–229

Weibull statistics, 32

X

Xerogel, 9

X-ray diffraction (XRD), 187

Y

Yield strength, 49, 156–160, 171, 240

Young modulus, 47, 49, 132

Z

Zeldovich factor, 118

Zero dimensional nanomaterials, 29

Zeta potential, 9, 153, 168, 239